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Edition	ECN NO.	Revised Page	Remark
1	ECN1601029	None	Initial Release
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1. 概述 Scope:

1.1 说明 Content

此份产品规格书是针对由昆山嘉华电子有限公司制造的 CARD HOLDER CONN.产品所定义的产品性能和测试方法。

This product specification defines the product performance and the test methods to ensure the performance of the CARD HOLDER CONN., which is manufactured by Kunshan Jiahua Electronics Co., Ltd.

1.2 限制 Qualification

所有的测试和检验必须依照本文件中所要求的规格、方法进行。一旦产品的重要制程发生 变更,必须立即进行品质验证和测试。

Tests and inspection shall be performed in accordance with the requirements, tests and methods contained herein. A re-qualification test shall be conducted immediately following all major process changes.

2. 参考文件 Referenced Documents:

EIA364

MIL-STD-883B: Methods 2022 solder Testing.

ISO 7816-1:Identification Cards-integrated circuit cards with contact-

dimension and location of the contacts.

GSM11.11:IETS subscriber identity module-interface specification

EIA 481-3 ,SMD tapping standard

若某些项目被发现本规格书中的内容与以上参考文件要求不一致时,一律依本规格书中的内容为测试依据。

In case of any contradiction between this document and referenced documents, this document will take precedence.

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3. 规格要求 Requirements:

3.1 应用条件 Application Condition:

- 3.1.1 额定电流: 0.5Amps DC Max. per contact CURRENT RATING: 0.5Amps DC Max. per contact
- 3.1.2 额定电压: 100 Volt DC Max. VOLTAGE RATING: 100 Volt DC Max

3.1.3 使用环境 Operating Environment:

温度: -25°C to +85°C,相对湿度:25%~85%,此条件下功能不可失效。

Temperature:-25°C to +85°C, Relative Humidity:25%~85%, Without loss of function.

3.1.4 储存环境 Storage Environment:

温度: -40°C to +85°C,相对湿度:25%~85%或更低,此条件下功能不可失效。

Temperature:-40°C to +85°C, Relative Humidity: 25%~85% or Less, Without loss of function.

3.2 绿色环保要求 Health, Safety and Environment

此产品中所有涉及环保有关的有害物质管控标准请参考嘉华系统文件:JH-GP-213

Hazardous substances (Environment related to be controlled substances) contained in this product should comply with the regulations specified by FAF's <u>JH-GP-213</u>.

3.3 测试说明 Test Description

此产品性能须满足本文件第4节中的各项规格要求。除非有特别申明,所有的测试和量测必须在以下条件中进行:

The product is designed to meet the requirements specified in section 3.4. Unless otherwise specified, all tests and measurements are to be performed under the following conditions:

温度 Temperature: 15 to 35℃

相对湿度 Relative Humidity: 25% to 75%

大气压 Atmospheric Pressure: 650 to 800 millimeters (25.6 to 31.5 inches) of Mercury.

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4.1 外观 Appearance		
项目 Items	规格要求 Requirements	测试方法 Test Methods
4.1 产品外观和尺寸检查 Appearance	=	依照相应的文件和规格书进行外观,功能,及 尺寸的检验量测. Visual, functional, and dimensional inspection complies with applicable specification and document.
4.2 电气 性能 Electric	al Performance :	
4.2.1 接触阻抗 ∟ow level contact resistance	初始接触阻抗: 100mΩMax; 试验后接触阻抗: 变化值 50mΩMax; Initial: 100mΩMax; After test: 50mΩMax Change	测量接触阻抗,测试电流小于 100mA,开 路电压 20mVMax Measure contact resistance of product and test card PCB with less than current of 100 mA (exception for the conductor resistance) Open voltage : 20mVMax
4.2.2 绝缘阻抗 Insulation resistance	初始绝缘阻抗: 1000 M Ω Min 试验后绝缘阻抗: 100 M Ω Min Initial:1000 M Ω Min After test:100 M Ω Min	测试电压: 直流 500V,测试时间: 1 分钟,测试相邻两端子之间的绝缘阻抗; Give DC 500V Voltage for 1 minutes and then measure insulation resistance of contact and contact
4.2.3 耐电压 Dielectric withstanding voltage	产品无击穿、飞弧现象 漏电流最大 0.2mA After the test, Neither creeping discharge nor flashover shall occur. Leakage current 0.2mA Max	两相邻端子之间加载交流 500V 电压 1 分 钟; Give AC 500 V in near contact and insulator for 1 minute
4.3 机械 性能 Mechar	nical Performance :	
4.3.1 Tray 保持力	 Tray 保持力:2N Min	TRAY 在铁壳退出时的保持力.
Tray 在有力 Tray retention forces	Tray 保持力: 2N Min Tray retention forces: 2N Min 耐久后 Tray 保持力: 1N Min Test after tray retention forces: 1N Min	退出速度: 25±3mm/min. Measured withdrawal force that resin grips and supports tray. Velocity of withdrawal:25±3mm/min.

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4.3.2 耐久 Durability	 试验后接触阻抗:变化值 50m ΩMax; 产品无断裂、无破损; After testing, contact resistance : Δ=50 m ΩMax; No have fracture, crack; 	产品焊板后,用 Tray 重复插拔 3000 次, 速度为 10 个循环/分, After Soldering of testing product at PCB, Repeat insert withdrawal of card as 5000 cycle to parallel 1 cycle:10 sec (10times per minute)
4.3.3 振动 Vibration	 没有物理损坏,端子无变形 不产生超过 1 微秒的瞬断 No have fracture, crack, terminal contact point shake of product No electrical discontinuity longer than 1 u sec. 	产品焊板后测试, 测试频率: 10-55-10HZ, 振幅: 1.52mm,X,Y,Z 三个方向每个方向振 动两个小时, (sweep time:30s) After attach at vibration plate and Soldering at test PCB, it test follow conditions : As condition of frequency:10-55- 10HZ,amplitude1.52mm,it test for two hours about each of X,Y,Z, axis(sweep time:30s)
4.3.4 推杆顶力测试 Level Riveting force test	1. 推杆顶力≫4kgf. 1. Riveting force ≫4kgf.	产品固定后,用顶针以每分钟 25.4mm 的 速度用顶针将推杆头部向下压 1mm,测量 其顶力。 Fix the product, apply a thimble to ejection rivet from the product at a speed of 25.4mm per minute, then measure the
4.3.5 推断力测试 Riveting force test	1. 铆钉推断力>10kgf. 1. Riveting force >10kgf.	产品固定后,用顶针以每分钟 25.4mm 的 速度将铆钉 从产品中顶出,测量其推断力。 Fix the product, apply a thimble to ejection rivet from the product at a speed of 25.4mm per minute, then measure the

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项目 Items	规格要求 Requirements	测试方法 Test Methods
4.4 环境 性能 Enviro	onmental Performance :	•
4.4.1 恒温恒湿 Humidity	 产品无损坏,端子无变形 测试后接触阻抗:变化值 50mΩMax No have fracture crack ,terminal contact point deflection and shake of product After testing contact resistance: Δ=50 mΩMax 	配合后的产品在以下条件下测试: 温度: 40±2°C; 相对湿度: 95%RH+/-3%RH 时间: 96 hours Mated connectors shall be subjected to the following condition: Temperature: 40±2°C Relative humidity: 95%RH+/-3%RH Period: 96 hours
4.4.2 耐低温 Low Temperature	 产品无损坏,端子无变形; 测试后接触阻抗:变化值 50 mΩMax No have fracture crack, terminal Contact point deflection and shake of product After testing contact resistance: Δ=50 mΩMax 	配合后的产品在以下条件下测试: 温度: -40 <u>+</u> 3°C; 时间: 96 hours The card shall be mated and exposed to the condition of -40±3°C for 96 hours. Recovery time 1~2 hours
4.4.3 耐高温 High temperature	 产品无损坏,端子无变形 试验后接触阻抗:变化值 50 mΩMax No have fracture crack ,terminal contact point deflection and shake of product After testing contact resistance: Δ=50 mΩMax; 	配合后的产品在以下条件下测试: 温度: 85±2°C 时间: 96h Mated connectors shall be subjected to the following condition: temperature: 85±2°C Duration: 96h
4.4.4 热冲击 Thermal shock	测试后满足相应机械及电气规格; 测试后接触阻抗:变化值 50 mΩMax After test: Δ=50 mΩMax	参考测试标准: EIA-364-32; -55℃和+85℃各 30 分钟,总计 5 个循环. Comply with method EIA-364-32. -55℃ for 30 minutes and +85℃ for 30 minutes for 5 cycles.
4.4.5 盐雾测试 Salt Spray Test	 产品无损坏,端子无变形 试验后接触阻抗:变化值 50 mΩMax No have fracture crack ,terminal contact point deflection and shake of product After testing contact resistance: 	盐水浓度:5±1%,时间:8小时 温度:35±2°C Mated connector shall be subjected to the following condition

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 $\Delta = 50 \text{ m} \Omega \text{Max};$

Concentration : $5\pm1\%$

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		Spray time: 48hours Temperature: 35±2°C			
4.4.6 可焊性 Solder ability	焊脚吃锡面积 95%以上 More than 95% of area dipped in molten solder should be coated by solder	温度: 250℃±5℃ 粘锡时间: 3±0.5 秒 Solder Temperature : 250℃±5℃ Immersion Duration : 3±0.5 seconds			
4.4.7 耐 Reflow 高温 Resistance to Reflow Soldering Heat	 无损坏,端子无变形; 产品结构无破坏; No have fracture crack ,terminal contact point deflection and shake of product No have break down outer feature/structure 	根据下图温度条件测试产品的耐焊接热 The connector shall be tested resistance to soldering heat in the following conditions, The temperature shall be measured on the surface of PCB Average rampup: 1.8℃/s MAX. Peak temperature 250℃ MAX. Peak temperature 250℃ MAX.			
4.4.8 机械冲击 Physical Shock	不产生超过 1 微秒的瞬断, 产品没有物理 破坏以及零件脱落,端子接触阻抗满足规 格要求. No electrical discontinuity longer than 1 u sec. No mechanical damage or looseness.Contact resistance specifications remain satisfied.	参考测试标准: EIA-364-27. 波形:半正弦波; 加速度: 490m/s2, 时间: 11 毫秒; 沿 X,Y,X 三个方向进行, 每个方 向完成正反 3 次冲击(总计 18 次冲击)			

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Group Number	А	В	C	D	Ε	F	G	Н	Ι
Contact Resistance	1,4		1,4, 7	1,3,5	1,3,	1,3	1,3		1,3
Insulation Resistance			2,8						
Dielectric Withstanding Voltage			3,9						
Retention force	2								
Durability	3								
Vibration									2
Riveting force test		2							
Level Riveting force test		1							
High Relative Humidity Exposure			5						
Low Temperature Exposure				2					
High Temperature Exposure				4					
Thermal Shock			6						
Salt Spray Test					2				
Solder ability						1			
Physical Shock							2		
Resistance to Soldering reflow Heat								1	

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